

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT4701474

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ANTHONY M.K. VERSINO	01/09/2017
MICHAEL DILL	12/05/2016
VICTOR TRUONG	12/05/2016
JOHN W. CROLL	01/09/2017
YASH SIDDHARTHA	12/08/2016
SAKIF B. FERDOUS	12/07/2016
RECEIVING PARTY DATA	
Name:	ILLINOIS TOOL WORKS INC.
Street Address:	155 HARLEM AVENUE
City:	GLENVIEW
State/Country:	ILLINOIS
Postal Code:	60025
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15819764
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	312-269-8048
Email:	hrawl@nge.com
Correspondent Name:	ADAM H. MASIA
Address Line 1:	2 NORTH LASALLE STREET, SUITE 1700
Address Line 2:	NEAL, GERBER & EISENBERG LLP
Address Line 4:	CHICAGO, ILLINOIS 60602
ATTORNEY DOCKET NUMBER:	025140-1515/66734-US
NAME OF SUBMITTER:	ADAM H. MASIA
SIGNATURE:	/Adam H. Masia/
DATE SIGNED:	11/22/2017

Total Attachments: 10

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ASSIGNMENT

WHEREAS, the undersigned, to wit, Anthony M.K. Versino, Michael Dill, Victor Truong, John W. Croll, Yash Siddhartha and Sakif B. Ferdous (hereinafter "ASSIGNORS"), are the lawful owners of an invention (the "INVENTION") described in United States Patent Application Serial No. 62/428,754 (the "PATENT APPLICATION"), which is entitled "MEASURING DEVICE," was filed in the U.S. Patent and Trademark Office on December 1, 2016, and is identified by Attorney Docket No. 025140-1363/66734-US-P1;

AND WHEREAS, Illinois Tool Works Inc. (hereinafter "ASSIGNEE"), a Delaware corporation having its principal office and place of business at 155 Harlem Avenue, Glenview, IL 60025, desires to acquire the entire right, title, and interest in the INVENTION and the PATENT APPLICATION;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, ASSIGNORS hereby sell, assign, transfer, and set over unto ASSIGNEE, its successors, assigns, nominees, or legal representatives, the full and exclusive right, title, and interest in and to the INVENTION and the PATENT APPLICATION in the United States and in all countries foreign to the United States, to be held and enjoyed by ASSIGNEE, its successors, assigns, nominees, or legal representatives as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this ASSIGNMENT not been made, including, without limitation:

- (1) all right, title, and interest to make: (i) applications for patent of the United States on the INVENTION, (ii) applications for patent of countries foreign to the United States on the INVENTION, and (iii) international applications under the Patent Cooperation Treaty (PCT) on the INVENTION;
- (2) all right, title, and interest to make: (i) applications for patent of countries foreign to the United States that claim priority in whole or in part, directly or indirectly, to the PATENT APPLICATION, and (ii) international applications under the Patent Cooperation Treaty (PCT) that claim priority in whole or in part, directly or indirectly, to the PATENT APPLICATION;
- (3) all right, title, and interest to make: (i) related applications for patent of the United States that claim priority in whole or in part, directly or indirectly, to the PATENT APPLICATION; and (ii) related applications for patent of countries foreign to the United States that claim priority in whole or in part, directly or indirectly, to one or more applications for patent in countries foreign to the United States that claim priority to the PATENT APPLICATION, including but not limited to any and all continuations, divisionals, continuations-in-part, reissues, extensions, reexaminations, and substitutions thereof;

- (4) all right, title, and interest in and to any patents issuing from any applications for patent of the United States on the INVENTION including, but not limited to: (i) any patents of the United States issuing from the PATENT APPLICATION; and (ii) any patents issuing from any related applications for patent of the United States that claim priority in whole or in part, directly or indirectly, to the PATENT APPLICATION, together with all improvements thereon and betterments thereof;
- (5) all right, title, and interest in and to any patents issuing from any applications for patent of countries foreign to the United States on the INVENTION including, but not limited to: (i) any patents issuing from any applications for patent of countries foreign to the United States that claim priority to the PATENT APPLICATION; and (ii) any patents issuing from any related applications for patent of countries foreign to the United States that claim priority in whole or in part, directly or indirectly, to one or more applications for patent in countries foreign to the United States that claim priority to the PATENT APPLICATION, together with all improvements thereon and betterments thereof;
- (6) any and all rights to sue for any past, present, and future infringement of any patents issuing from any applications for patent of the United States on the INVENTION including, but not limited to: (i) any patents of the United States issuing from the PATENT APPLICATION; and (ii) any patents issuing from any related applications for patent of the United States that claim priority in whole or in part, directly or indirectly, to the PATENT APPLICATION, including, but not limited to, the right to collect and receive any damages, royalties, or settlements for such infringements; all rights to sue for injunctive or other equitable relief; and all causes of action relating to any patents issuing from any applications for patent of the United States on the INVENTION including, but not limited to: (i) any patents of the United States issuing from the PATENT APPLICATION; and (ii) any patents issuing from any related applications for patent of the United States that claim priority in whole or in part, directly or indirectly, to the PATENT APPLICATION; and
- (7) any and all rights to sue for any past, present, and future infringement of any patents issuing from any applications for patent of countries foreign to the United States on the INVENTION including, but not limited to: (i) any patents issuing from any applications for patent of countries foreign to the United States that claim priority to the PATENT APPLICATION; and (ii) any patents issuing from an related applications for patent of countries foreign to the United States that claim priority in whole or in part, directly or indirectly, to one or more applications for patent in countries foreign to the United States that claim priority to the PATENT APPLICATION, including, but not limited to, the right to collect and receive any damages, royalties, or settlements for such infringements; all rights to sue for injunctive or other equitable relief; and all causes of action relating to any patents issuing from

any applications for patent of countries foreign to the United States on the INVENTION including, but not limited to: (i) any patents issuing from any applications for patent of countries foreign to the United States that claim priority to the PATENT APPLICATION; and (ii) any patents issuing from any related applications for patent of countries foreign to the United States that claim priority in whole or in part, directly or indirectly, to one or more applications for patent in countries foreign to the United States that claim priority to the PATENT APPLICATION.

ASSIGNORS hereby authorize and request the Commissioner of Patents of the United States to issue any patents issuing from an application for patent of the United States on the INVENTION including, but not limited to: (i) any patents of the United States issuing from the PATENT APPLICATION; and (ii) any patents issuing from any related applications for patent of the United States that claim priority in whole or in part, directly or indirectly, to the PATENT APPLICATION, to ASSIGNEE, its successors, legal representatives, nominees, or assigns.

ASSIGNORS hereby authorize and request that all patents issuing from any applications for patent in countries foreign to the United States on the INVENTION including, but not limited to: (i) any patents issuing from any applications for patent of countries foreign to the United States that claim priority to the PATENT APPLICATION; and (ii) any patents issuing from any related applications for patent of countries foreign to the United States that claim priority in whole or in part, directly or indirectly, to one or more applications for patent in countries foreign to the United States that claim priority to the PATENT APPLICATION, be issued to ASSIGNEE, its successors, legal representatives, nominees, or assigns.

ASSIGNORS hereby covenant and agree that ASSIGNORS will, upon request of ASSIGNEE, its successors, legal representatives, nominees, or assigns and without further remuneration, fully cooperate with ASSIGNEE in preparing, filing, and procuring any applications for patent in the United States and in countries foreign to the United States on the INVENTION.

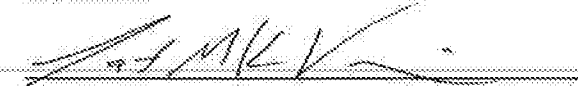
ASSIGNORS hereby further covenant and agree that ASSIGNORS will, upon request of ASSIGNEE, its successors, legal representatives, nominees, or assigns and without further remuneration, execute and deliver any papers that may be reasonably necessary to ASSIGNEE's, its successors', legal representatives', nominees', or assigns' full enjoyment, protection, enforcement, and title in and to the INVENTION and the PATENT APPLICATION and any and all rights hereby transferred, including, but not limited to, all oaths, declarations, affidavits, and attestations for and related to the INVENTION, the PATENT APPLICATION, and any and all applications for patent on the INVENTION of the United States and of countries foreign to the United States.

ASSIGNORS hereby further covenant and agree that ASSIGNORS will, upon request of ASSIGNEE, its successors, legal representatives, nominees, or assigns and without further remuneration, provide any information, testify in any legal proceeding, and take any other actions that may be reasonably necessary to ASSIGNEE's, its successors',

legal representatives', nominees', or assigns' full enjoyment, protection, enforcement, and title in and to the INVENTION and the PATENT APPLICATION and any and all rights hereby transferred.

Signature

Date Signed


Name: Anthony M.K. Versino

1/9/2017

Address: 2450 Chambord Drive
Buffalo Grove, IL 60089

Before me personally appeared the person whose name is subscribed to the foregoing instrument, and executed the foregoing instrument in my presence for the purpose contained therein, by signing his/her name hereto.

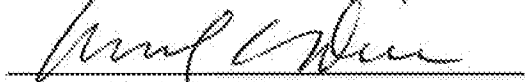
Signature

Date Signed



1/9/2017

Signature



Name: Michael Dill

Address: 205 Pleasant Drive
Elk Grove Village, IL 60007

Date Signed

12/5/16

Before me personally appeared the person whose name is subscribed to the foregoing instrument, and executed the foregoing instrument in my presence for the purpose contained therein, by signing his/her name hereto.

Signature

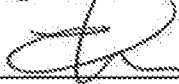


VICTOR TRUONG

Date Signed

12/5/16

Signature



Name: Victor Truong

Date Signed

12/5/16

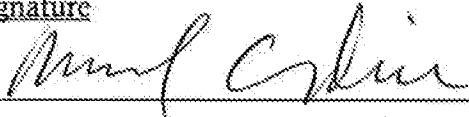
Address: 1221 Cambia Drive

Unit 1309

Schaumburg, IL 60193

Before me personally appeared the person whose name is subscribed to the foregoing instrument, and executed the foregoing instrument in my presence for the purpose contained therein, by signing his/her name hereto.

Signature



MICHAEL C. DILL

Date Signed

12/5/16

Signature


Name: John W. Croll

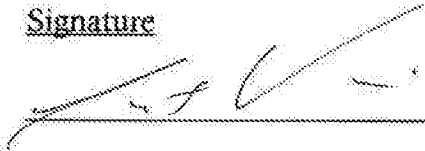
Date Signed

1/9/2017

Address: 1351 N Wolcott Avenue
Chicago, IL 60622

Before me personally appeared the person whose name is subscribed to the foregoing instrument, and executed the foregoing instrument in my presence for the purpose contained therein, by signing his/her name hereto.


Signature



Date Signed

1/9/2017

Signature



Name: Yash Siddhartha

Address: 1242 N Milwaukee Avenue
Chicago, IL 60622

Date Signed

12/8/2016

Before me personally appeared the person whose name is subscribed to the foregoing instrument, and executed the foregoing instrument in my presence for the purpose contained therein, by signing his/her name hereto.

Signature



Date Signed

12/8/16

Signature

Sakif B. Ferdous

Name: Sakif B. Ferdous

Address: 205 W Miner Street

Arlington Heights, IL 60005

Date Signed

12/07/16

Before me personally appeared the person whose name is subscribed to the foregoing instrument, and executed the foregoing instrument in my presence for the purpose contained therein, by signing his/her name hereto.

Signature

DAVID FLY

DAVID FLY

Date Signed

12/07/16